ne<mark>x</mark>peria

Important notice

Dear Customer,

On 7 February 2017 the former NXP Standard Product business became a new company with the tradename **Nexperia**. Nexperia is an industry leading supplier of Discrete, Logic and PowerMOS semiconductors with its focus on the automotive, industrial, computing, consumer and wearable application markets

In data sheets and application notes which still contain NXP or Philips Semiconductors references, use the references to Nexperia, as shown below.

Instead of <u>http://www.nxp.com</u>, <u>http://www.philips.com/</u> or <u>http://www.semiconductors.philips.com/</u>, use <u>http://www.nexperia.com</u>

Instead of sales.addresses@www.nxp.com or sales.addresses@www.semiconductors.philips.com, use **salesaddresses@nexperia.com** (email)

Replace the copyright notice at the bottom of each page or elsewhere in the document, depending on the version, as shown below:

- © NXP N.V. (year). All rights reserved or © Koninklijke Philips Electronics N.V. (year). All rights reserved

Should be replaced with:

- © Nexperia B.V. (year). All rights reserved.

If you have any questions related to the data sheet, please contact our nearest sales office via e-mail or telephone (details via **salesaddresses@nexperia.com**). Thank you for your cooperation and understanding,

Kind regards,

Team Nexperia

45 V, 500 mA NPN general-purpose transistors Rev. 06 — 17 November 2009

Product data sheet

Product profile 1.

1.1 General description

NPN general-purpose transistors.

Type number	Package	Package			
	NXP	JEITA			
BC817	SOT23	-	BC807		
BC817W	SOT323	SC-70	BC807W		
BC337[1]	SOT54 (TO-92)	SC-43A	BC327		

[1] Also available in SOT54A and SOT54 variant packages (see Section 2).

1.2 Features

- High current
- Low voltage

1.3 Applications

General-purpose switching and amplification

1.4 Quick reference data

Table 2.	Quick reference data						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V _{CEO}	collector-emitter voltage	open base; I _C = 10 mA		-	-	45	V
I _C	collector current (DC)			-	-	500	mA
I _{CM}	peak collector current			-	-	1	А
h _{FE}	DC current gain	I _C = 100 mA;	[1]	-	-	-	
	BC817; BC817W; BC337	$V_{CE} = 1 V$		100	-	600	
	BC817-16; BC817-16W; BC337-16			100	-	250	
	BC817-25; BC817-25W; BC337-25			160	-	400	
	BC817-40; BC817-40W; BC337-40			250	-	600	

 $\label{eq:point} \begin{tabular}{ll} \begin{$



45 V, 500 mA NPN general-purpose transistors

2. Pinning information

Pin	Description	Simplified outline	Symbol
SOT23			
1	base		
2	emitter		
3	collector	1 2	1 — (sym02
SOT323			
1	base		
2	emitter		
3	collector		1 — K
SOT54			
1	emitter		
2	base		
3	collector	1 2 001aab347	2 — (sym02
SOT54A			
1	emitter		
2	base		
3	collector	001aab348	2 sym02
SOT54 va	riant		
1	emitter		
2	base	-tea	
3	collector		2 — (sym02

BC817_BC817W_BC337_6

45 V, 500 mA NPN general-purpose transistors

3. Ordering information

Table 4. Ordering information						
Type number ^[1]	Package	age				
	Name	Description	Version			
BC817	-	plastic surface mounted package; 3 leads	SOT23			
BC817W	SC-70	plastic surface mounted package; 3 leads	SOT323			
BC337 ^[2]	SC-43A	plastic single-ended leaded (through hole) package; 3 leads	SOT54			

[1] Valid for all available selection groups.

[2] Also available in SOT54A and SOT54 variant packages (see Section 2 and Section 9).

4. Marking

Table 5. Marking codes	
Type number	Marking code ^[1]
BC817	6D*
BC817-16	6A*
BC817-25	6B*
BC817-40	6C*
BC817W	6D*
BC817-16W	6A*
BC817-25W	6B*
BC817-40W	6C*
BC337	C337
BC337-16	C33716
BC337-25	C33725
BC337-40	C33740

[1] * = -: made in Hong Kong

* = p: made in Hong Kong

* = t: made in Malaysia

* = W: made in China

45 V, 500 mA NPN general-purpose transistors

5. Limiting values

Table 6. In accorda	Limiting values ince with the Absolute Maxim	um Rating System (I	EC 6013	4).		
Symbol	Parameter	Conditions		Min	Max	Unit
V _{CBO}	collector-base voltage	open emitter		-	50	V
V_{CEO}	collector-emitter voltage	open base; I _C = 10 mA		-	45	V
V_{EBO}	emitter-base voltage	open collector		-	5	V
I _C	collector current (DC)			-	500	mA
I _{CM}	peak collector current			-	1	А
I _{BM}	peak base current			-	200	mA
P _{tot}	total power dissipation					
	BC817	$T_{amb} \le 25 \ ^{\circ}C$	[1][2]	-	250	mW
	BC817W	$T_{amb} \le 25 \ ^{\circ}C$	[1][2]	-	200	mW
	BC337	$T_{amb} \le 25 \ ^{\circ}C$	[1][2]	-	625	mW
T _{stg}	storage temperature			-65	+150	°C
Tj	junction temperature			-	150	°C
T _{amb}	ambient temperature			-65	+150	°C

[1] Transistor mounted on an FR4 printed-circuit board, single-sided copper, tin-plated and standard footprint.

[2] Valid for all available selection groups.

6. Thermal characteristics

Table 7.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-a)}	thermal resistance from junction to ambient					
	BC817	$T_{amb} \le 25 \ ^{\circ}C$	<u>[1][2]</u> _	-	500	K/W
	BC817W	$T_{amb} \le 25 \ ^{\circ}C$	<u>[1][2]</u> _	-	625	K/W
	BC337	$T_{amb} \le 25 \ ^{\circ}C$	<u>[1][2]</u> _	-	200	K/W

[1] Transistor mounted on an FR4 printed-circuit board, single-sided copper, tin-plated and standard footprint.

[2] Valid for all available selection groups.

BC817; BC817W; BC337

45 V, 500 mA NPN general-purpose transistors

7. Characteristics

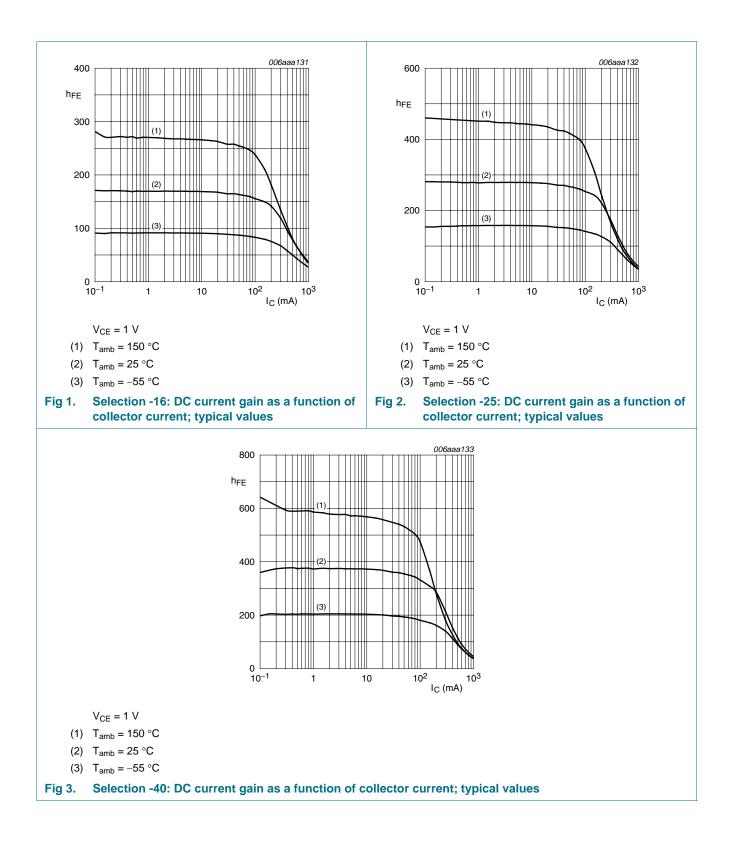
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I _{CBO}	collector-base cut-off current	$I_{E} = 0 \text{ A}; V_{CB} = 20 \text{ V}$		-	-	100	nA
		I _E = 0 A; V _{CB} = 20 V; T _j = 150 °C		-	-	5	μΑ
I _{EBO}	emitter-base cut-off current	$I_{C} = 0 \text{ A}; V_{EB} = 5 \text{ V}$		-	-	100	nA
BC817; BC817- BC337- BC817-	DC current gain	$I_{C} = 100 \text{ mA}; V_{CE} = 1 \text{ V}$	<u>[1]</u>				
	BC817; BC817W; BC337			100	-	600	
	BC817-16; BC817-16W; BC337-16			100	-	250	
	BC817-25; BC817-25W; BC337-25			160	-	400	
	BC817-40; BC817-40W; BC337-40			250	-	600	
h _{FE}	DC current gain	$I_{C} = 500 \text{ mA}; V_{CE} = 1 \text{ V}$	<u>[1]</u>	40	-	-	
V _{CEsat}	collector-emitter saturation voltage	$I_{\rm C}$ = 500 mA; $I_{\rm B}$ = 50 mA	<u>[1]</u>	-	-	700	mV
V _{BE}	base-emitter voltage	$I_{C} = 500 \text{ mA}; V_{CE} = 1 \text{ V}$	[2]	-	-	1.2	V
C _c	collector capacitance	$I_E = i_e = 0 \text{ A}; V_{CB} = 10 \text{ V};$ f = 1 MHz		-	3	-	pF
f _T	transition frequency	I _C = 10 mA; V _{CE} = 5 V; f = 100 MHz		100	-	-	MHz

[1] Pulse test: $t_p \le 300 \ \mu s$; $\delta \le 0.02$.

[2] V_{BE} decreases by approximately 2 mV/K with increasing temperature.

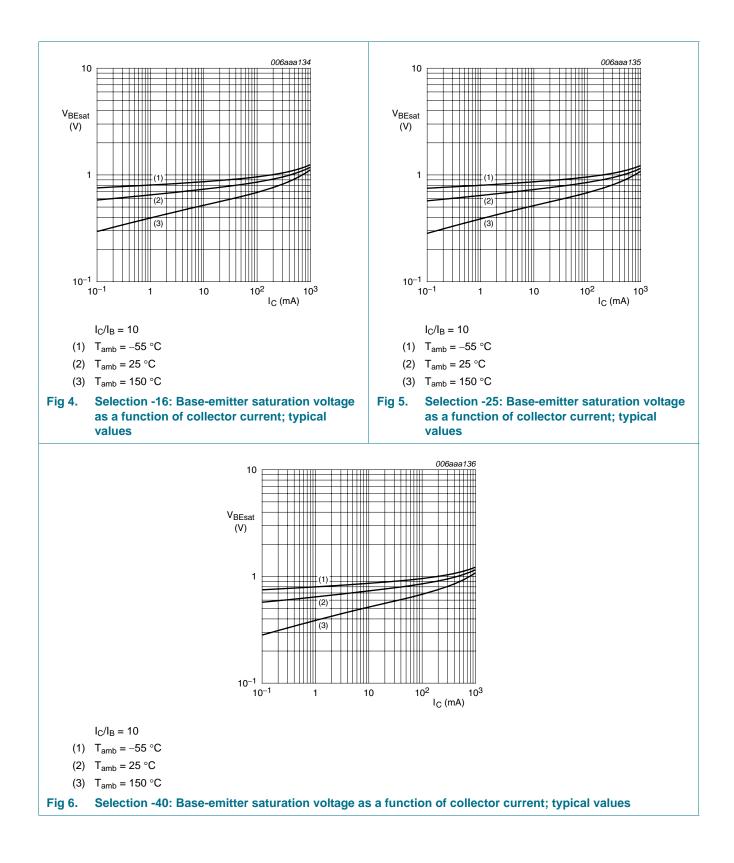
BC817; BC817W; BC337

45 V, 500 mA NPN general-purpose transistors



BC817; BC817W; BC337

45 V, 500 mA NPN general-purpose transistors



BC817_BC817W_BC337_6

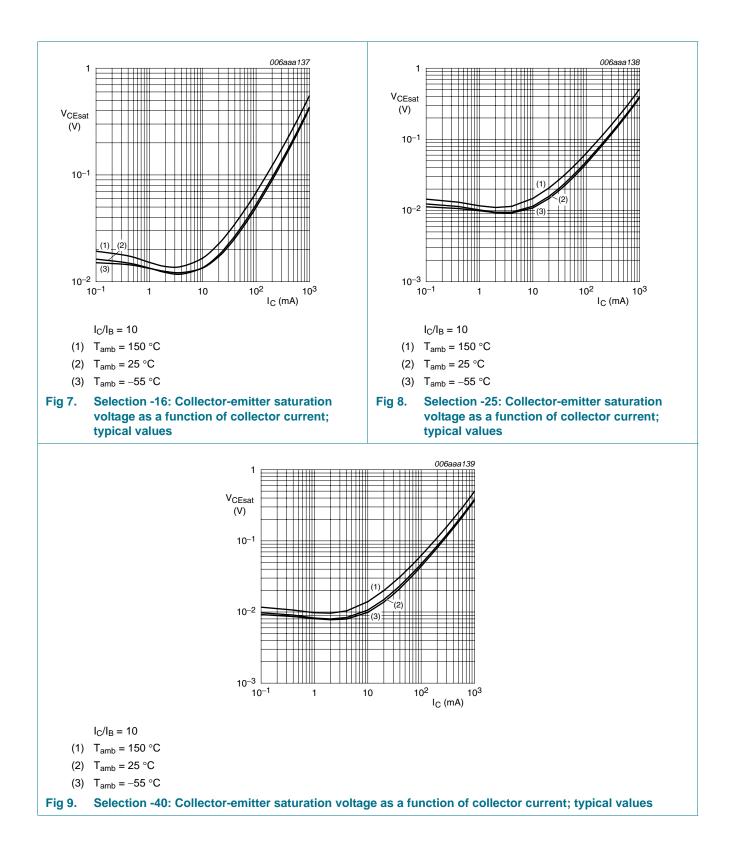
Product data sheet

Downloaded from Arrow.com.

7 of 19

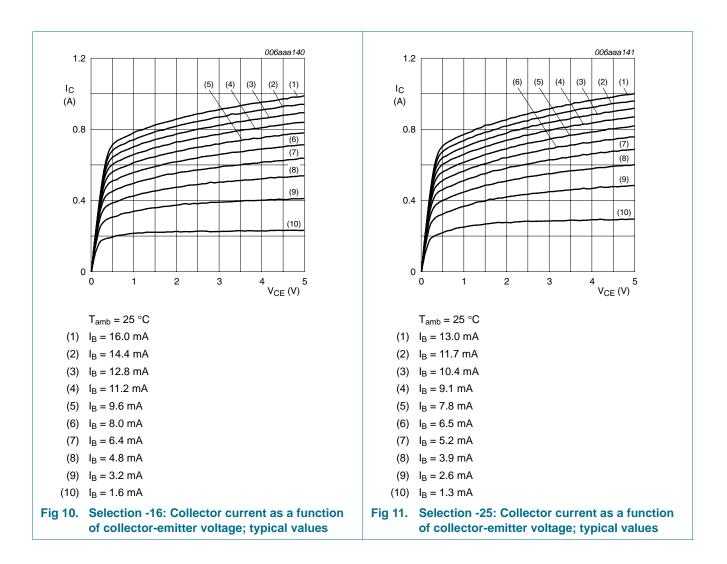
BC817; BC817W; BC337

45 V, 500 mA NPN general-purpose transistors



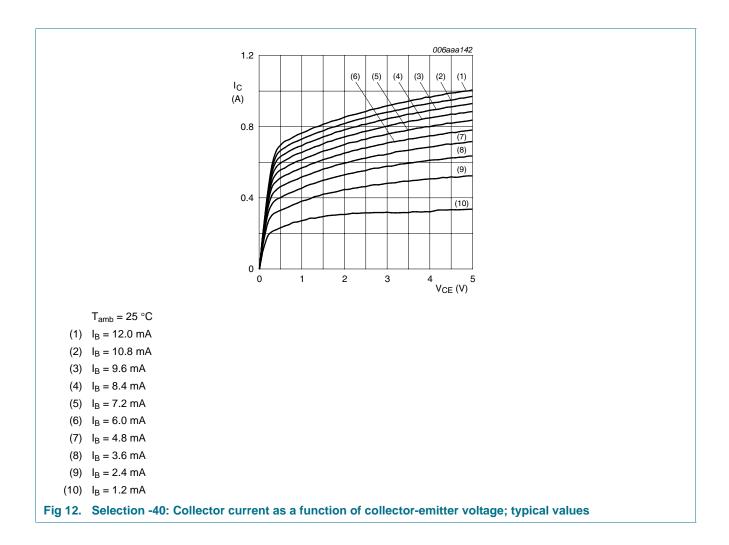
BC817; BC817W; BC337

45 V, 500 mA NPN general-purpose transistors



BC817; BC817W; BC337

45 V, 500 mA NPN general-purpose transistors



10 of 19

45 V, 500 mA NPN general-purpose transistors

8. Package outline

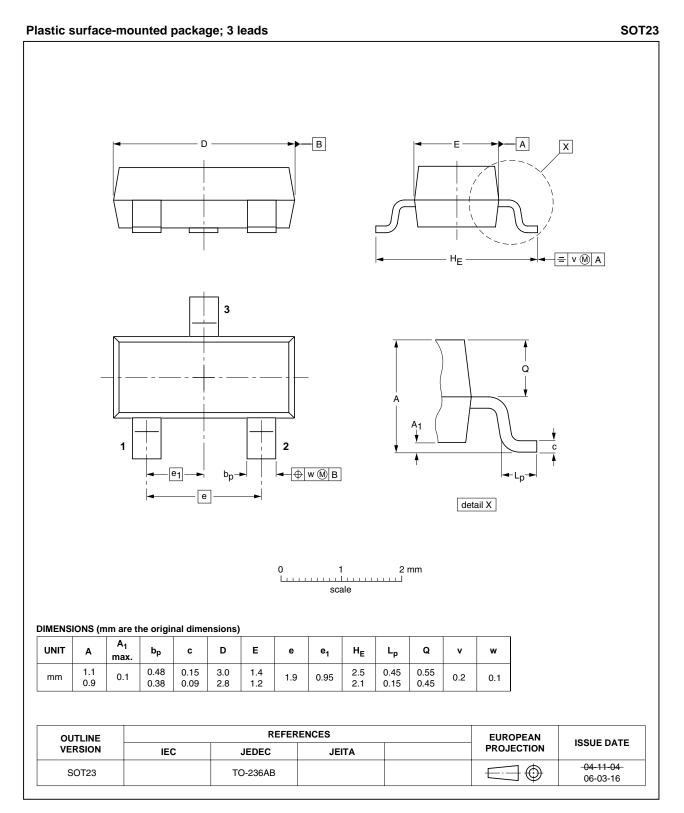


Fig 13. Package outline SOT23 (TO-236AB)

BC817_BC817W_BC337_6

BC817; BC817W; BC337

45 V, 500 mA NPN general-purpose transistors

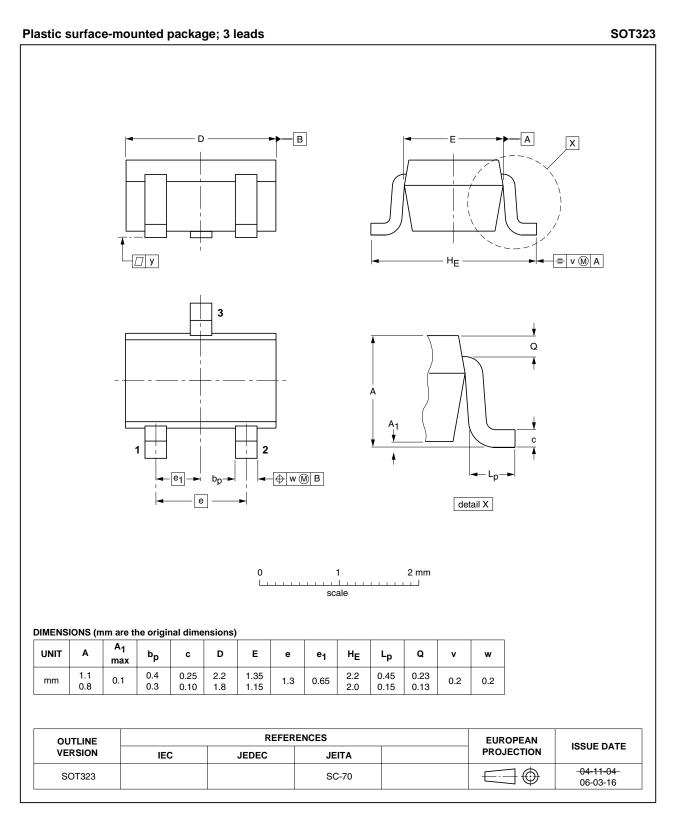


Fig 14. Package outline SOT323 (SC-70)

BC817_BC817W_BC337_6

BC817; BC817W; BC337

45 V, 500 mA NPN general-purpose transistors

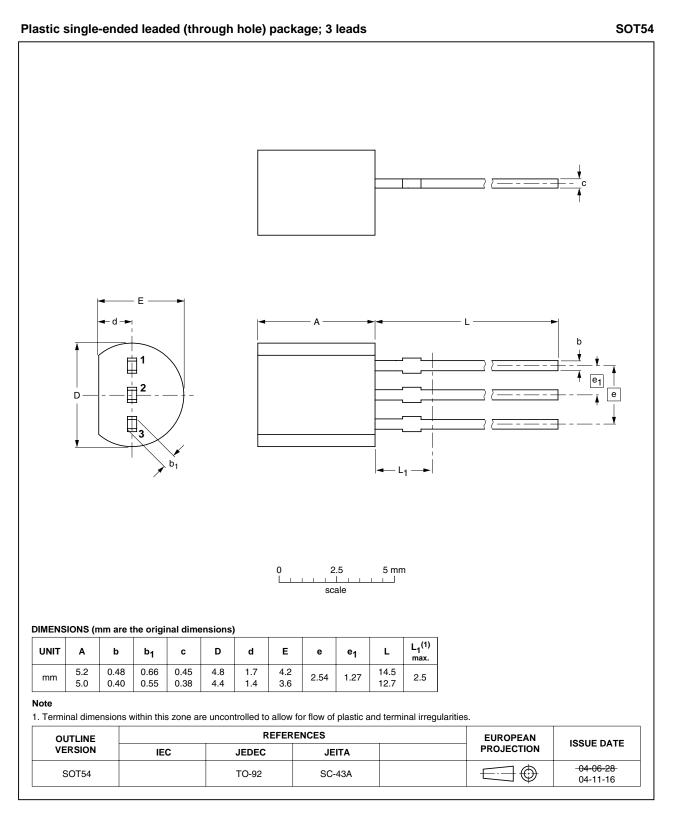


Fig 15. Package outline SOT54 (SC-43A/TO-92)

BC817_BC817W_BC337_6

45 V, 500 mA NPN general-purpose transistors

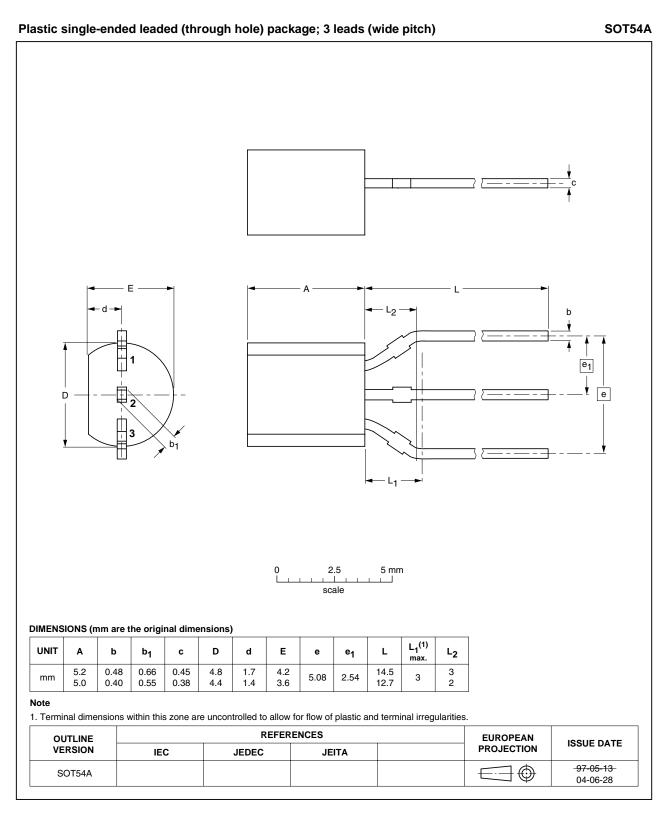


Fig 16. Package outline SOT54A

BC817_BC817W_BC337_6

45 V, 500 mA NPN general-purpose transistors

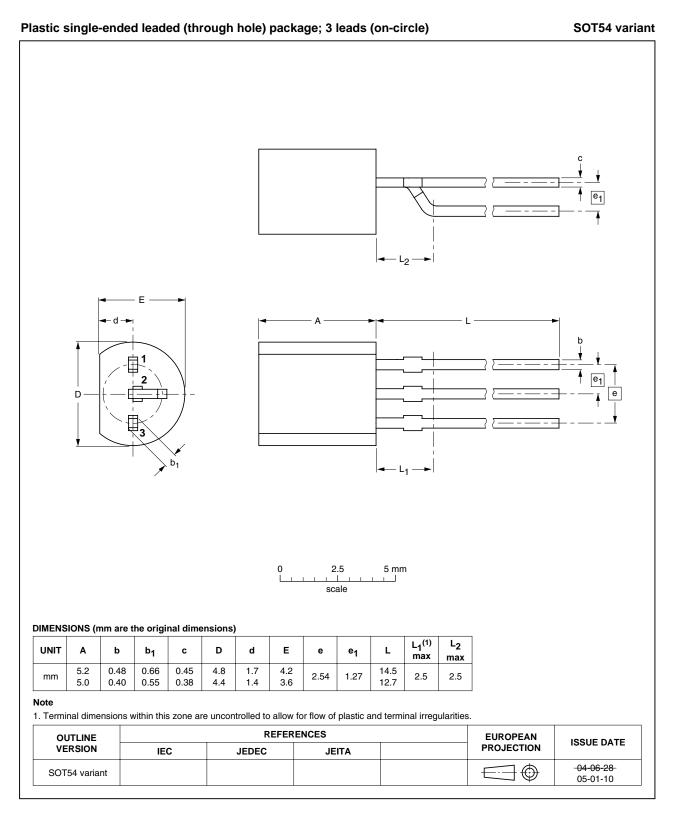


Fig 17. Package outline SOT54 variant

BC817_BC817W_BC337_6

45 V, 500 mA NPN general-purpose transistors

9. Packing information

Table 9. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number	Package	Description	Packing	Packing quantity		
			3000	5000	10000	
BC817	SOT23	4 mm pitch, 8 mm tape and reel	-215	-	-235	
BC817W	SOT323	4 mm pitch, 8 mm tape and reel	-115	-	-135	
BC337	SOT54	bulk, straight leads	-	-412	-	
BC337	SOT54A	tape and reel, wide pitch	-	-	-116	
BC337	SOT54A	tape ammopack, wide pitch	-	-	-126	
BC337	SOT 54 variant	bulk, delta pinning (on-circle)	-	-112	-	

[1] For further information and the availability of packing methods, see Section 12.

Downloaded from Arrow.com.

45 V, 500 mA NPN general-purpose transistors

10. Revision history

Table 10. Revision h	istory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
BC817_BC817W_ BC337_6	20091117	Product data sheet	-	BC817_BC817W_ BC337_5
Modifications:	including new content. • <u>Table 3 "Pinni</u> • <u>Figure 13 "Pa</u>	et was changed to reflect t / legal definitions and discla ing": updated uckage outline SOT23 (TO- uckage outline SOT323 (SO	aimers. No changes we <u>236AB)"</u> : updated	
BC817_BC817W_ BC337_5	20050121	Product data sheet	CPCN200302007F1	BC817_4; BC817W_SER_4; BC337_3
BC817_4	20040105	Product specification	-	BC817_3
BC817W_SER_4	20040225	Product specification	-	BC817W_SER_3
BC337 3	19990415	Product specification	-	BC337 338 CNV 2

17 of 19

45 V, 500 mA NPN general-purpose transistors

11. Legal information

11.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

The term 'short data sheet' is explained in section "Definitions". [2]

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://w

11.2 Definitions

Draft - The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

11.3 **Disclaimers**

General - Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information

Right to make changes - NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use - NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in medical, military, aircraft, space or life support equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental

damage. NXP Semiconductors accepts no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Applications — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Limiting values - Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) may cause permanent damage to the device. Limiting values are stress ratings only and operation of the device at these or any other conditions above those given in the Characteristics sections of this document is not implied. Exposure to limiting values for extended periods may affect device reliability.

Terms and conditions of sale - NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at http://www.nxp.com/profile/terms, including those pertaining to warranty, intellectual property rights infringement and limitation of liability, unless explicitly otherwise agreed to in writing by NXP Semiconductors. In case of any inconsistency or conflict between information in this document and such terms and conditions, the latter will prevail.

No offer to sell or license - Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

Export control — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from national authorities.

Quick reference data - The Quick reference data is an extract of the product data given in the Limiting values and Characteristics sections of this document, and as such is not complete, exhaustive or legally binding.

11.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

12. Contact information

For more information, please visit: http://www.nxp.com

For sales office addresses, please send an email to: salesaddresses@nxp.com

BC817; BC817W; BC337

45 V, 500 mA NPN general-purpose transistors

13. Contents

1	Product profile 1
1.1	General description 1
1.2	Features
1.3	Applications 1
1.4	Quick reference data 1
2	Pinning information 2
3	Ordering information 3
4	Marking
5	Limiting values 4
6	Thermal characteristics 4
7	Characteristics 5
8	Package outline 11
9	Packing information 16
10	Revision history 17
11	Legal information 18
11.1	Data sheet status 18
11.2	Definitions
11.3	Disclaimers
11.4	Trademarks
12	Contact information 18
13	Contents 19

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.

founded by
PHILIPS

© NXP B.V. 2009. All rights reserved. For more information, please visit: http://www.nxp.com For sales office addresses, please send an email to: salesaddresses@nxp.com

Date of release: 17 November 2009 Document identifier: BC817_BC817W_BC337_6